



Reliability of Materials and the Systems

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Message from the Guest Editors

Dear Colleagues,

Reliability is now receiving significant attention from industries such as electronics, automotive, heavy-chemical industries, and power plants. The international competitiveness of industries in a globalized economy is closely tied to the high reliability of materials and systems.

To this end, this Special Issue showcases the latest reliability theory and applications, prognostics and health management (PHM) research trends, advanced material processing technologies, reliability assessment, theoretical and experimental reliability analysis, and other related topics.

This Special Issue welcomes full article submissions from presenters, and speakers at the Annual Conference of the Reliability Division of the Korean Society of Mechanical Engineers (KSME), held February 26–28, 2020 in Jeju, Republic of Korea.

Warm Regards,
Prof. Dr. Hyunseok Oh
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Guest Editor





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Message from the Editor-in-Chief

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